

**MIT, Spring 2005**

**6.012**

**Microelectronic Devices and Circuits**

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# Lecture 1 – 6.012 overview

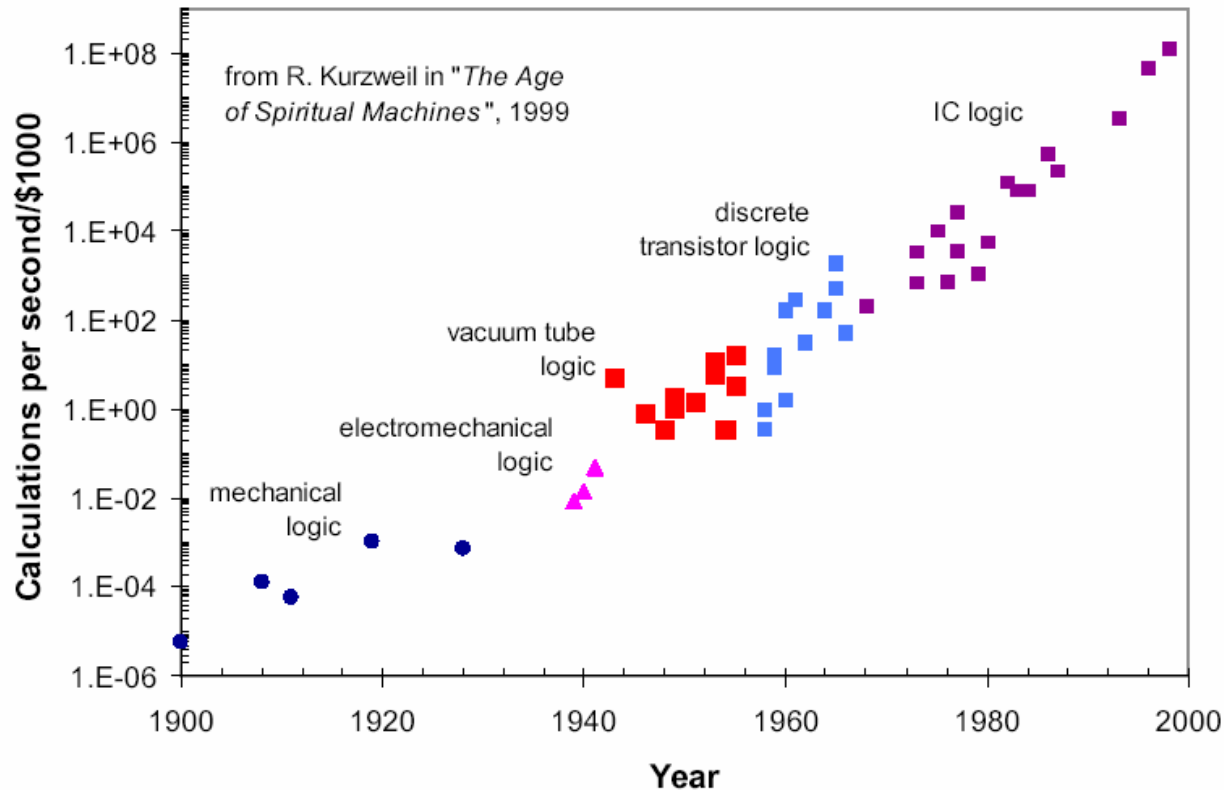
February 1, 2005

- Contents:
  - Overview of 6.012
- Reading Assignment:
  - Howe and Sodini, Ch. 1

# Overview of 6.012

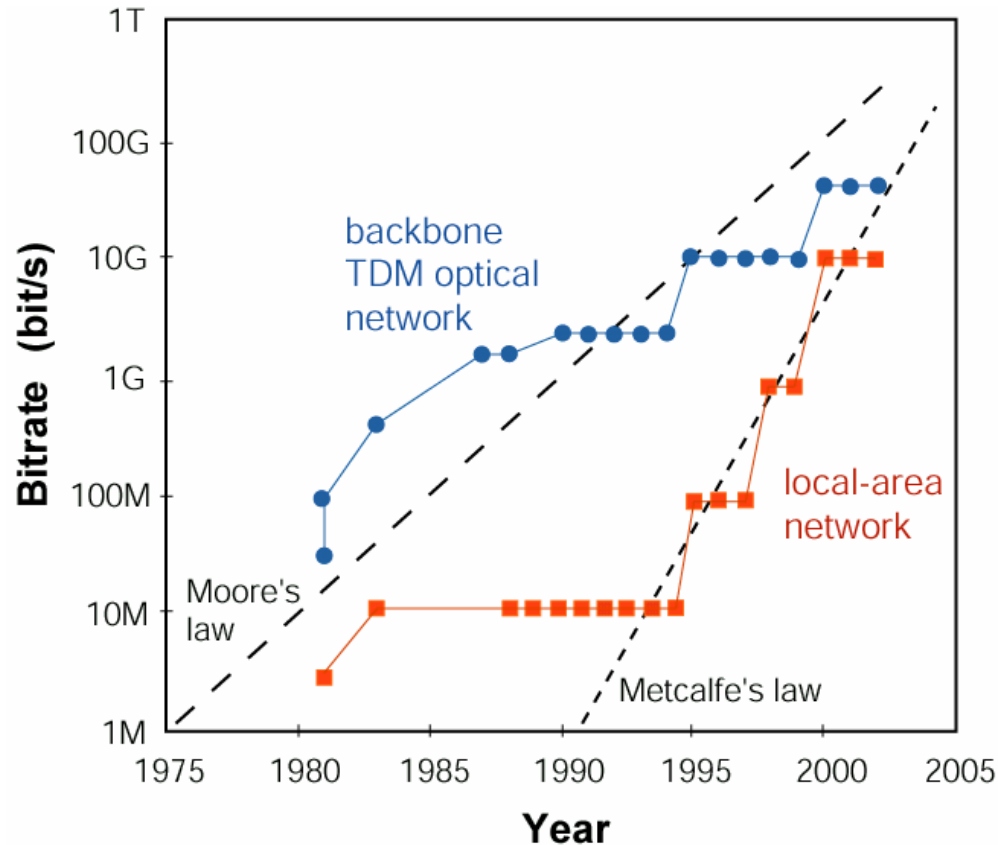
- Introductory subject to microelectronic devices and circuits
- Microelectronics is the cornerstone of:
  - Computer revolution
  - Communications revolution
  - Consumer Electronics revolution

# Microelectronics: cornerstone of computing revolution



In last 30 years, computer performance per dollar has improved more than a million fold!

# Microelectronics: cornerstone of communications revolution



In last 20 years, communication bandwidth through a single optical fiber has increased by ten-thousand fold.

# Microelectronics: cornerstone of consumer electronics revolution



Low power electronics enabling a variety of portable devices

# Si digital microelectronics today

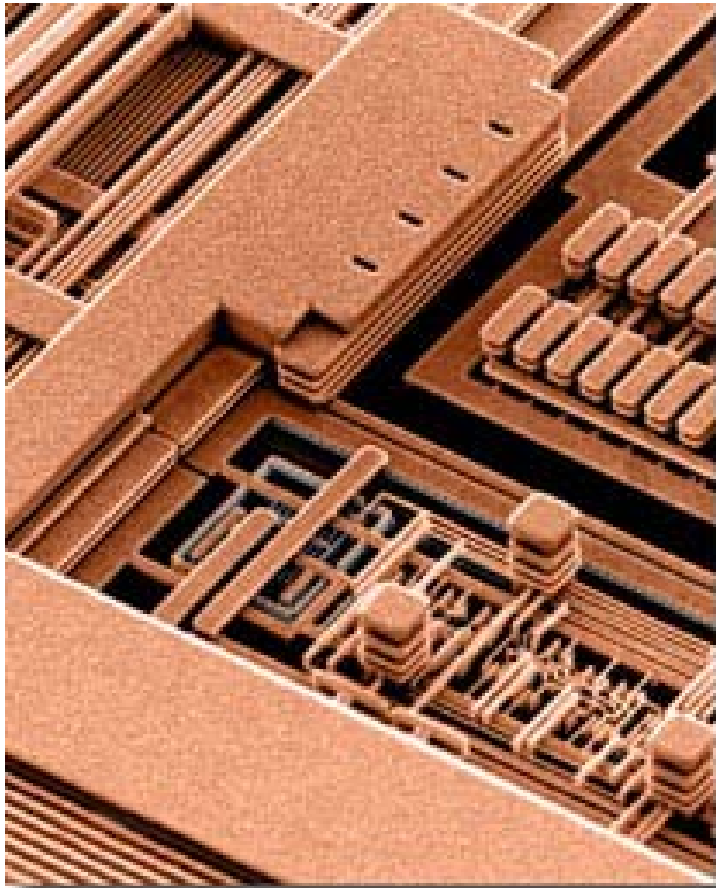


**Take the cover off a microprocessor. What do you see?**

- A thick web of interconnects, many levels deep.
- High density of very small transistors.

Intel's Pentium IV

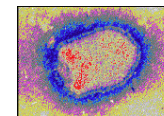
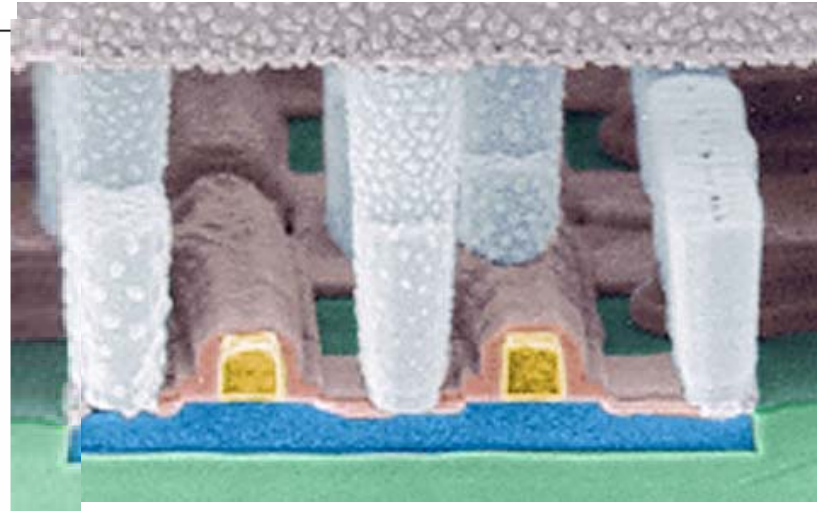
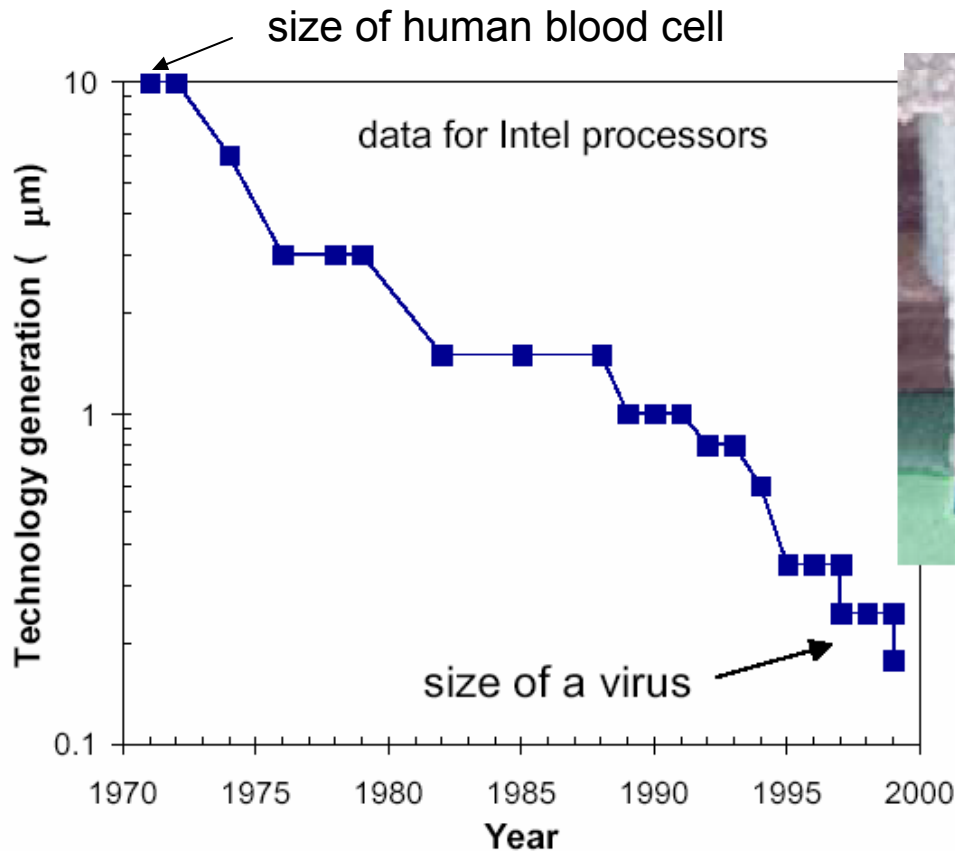
# Interconnects



Today, as many as 7 levels of interconnect using Cu.



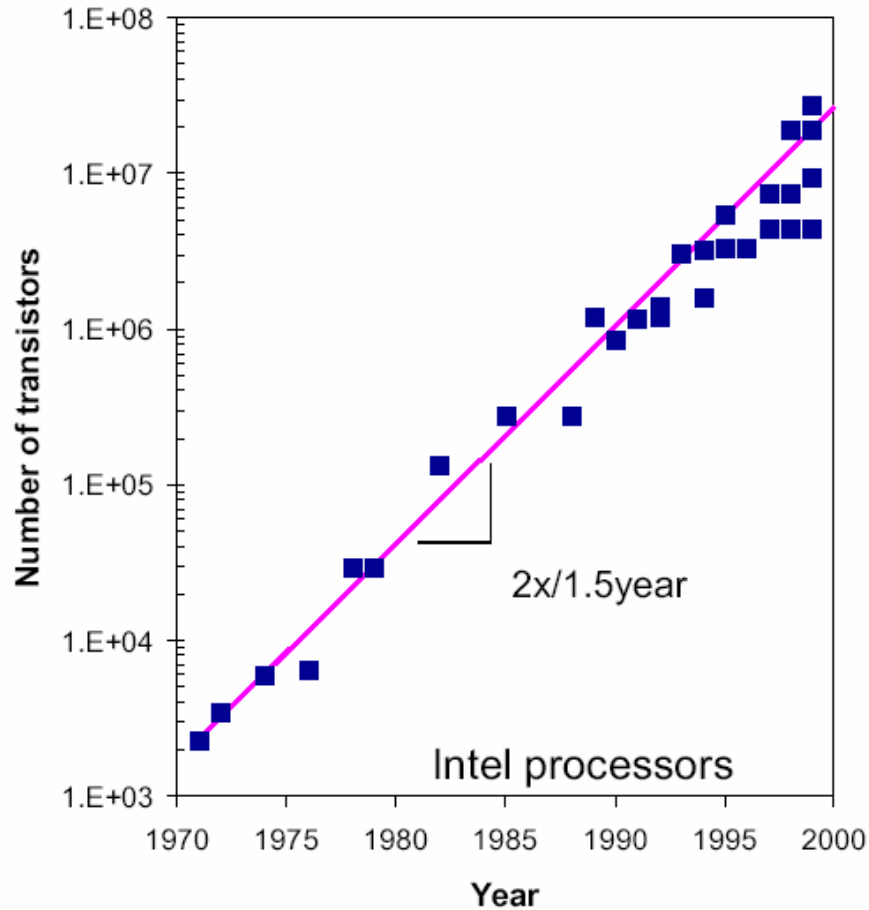
# Transistor size scaling



Rabies virus at same scale

2-orders of magnitude reduction in transistor size in 30 years.

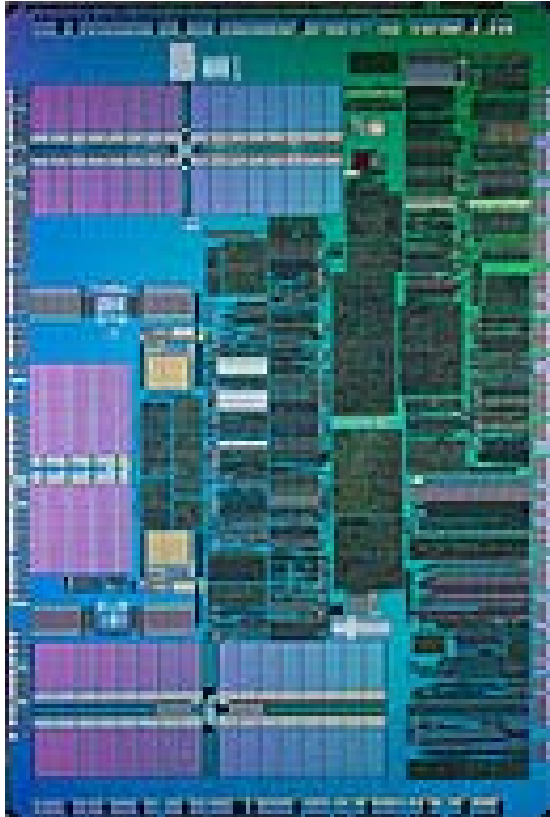
# Evolution of transistor density



**Moore's Law:** doubling of transistor density every 1.5 years

4-orders of magnitude improvement in 30 years.

# Benefits of increasing transistor integration

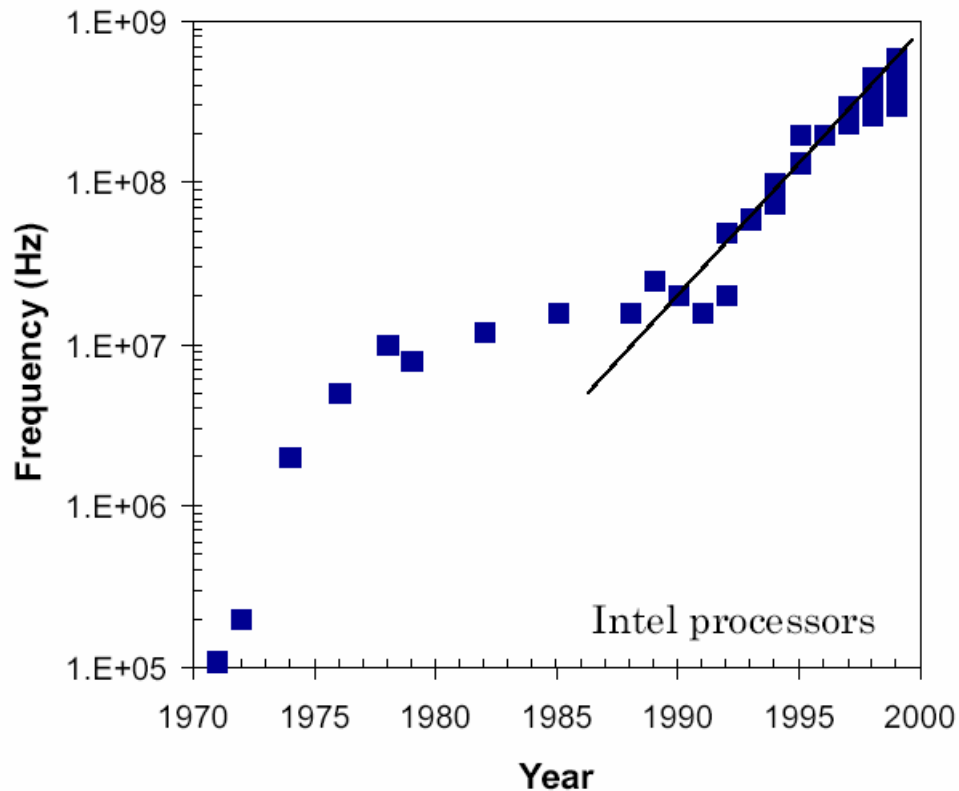


Exponential improvements in:

- system performance
- cost-per-function,
- power-per-function, and
- system reliability.

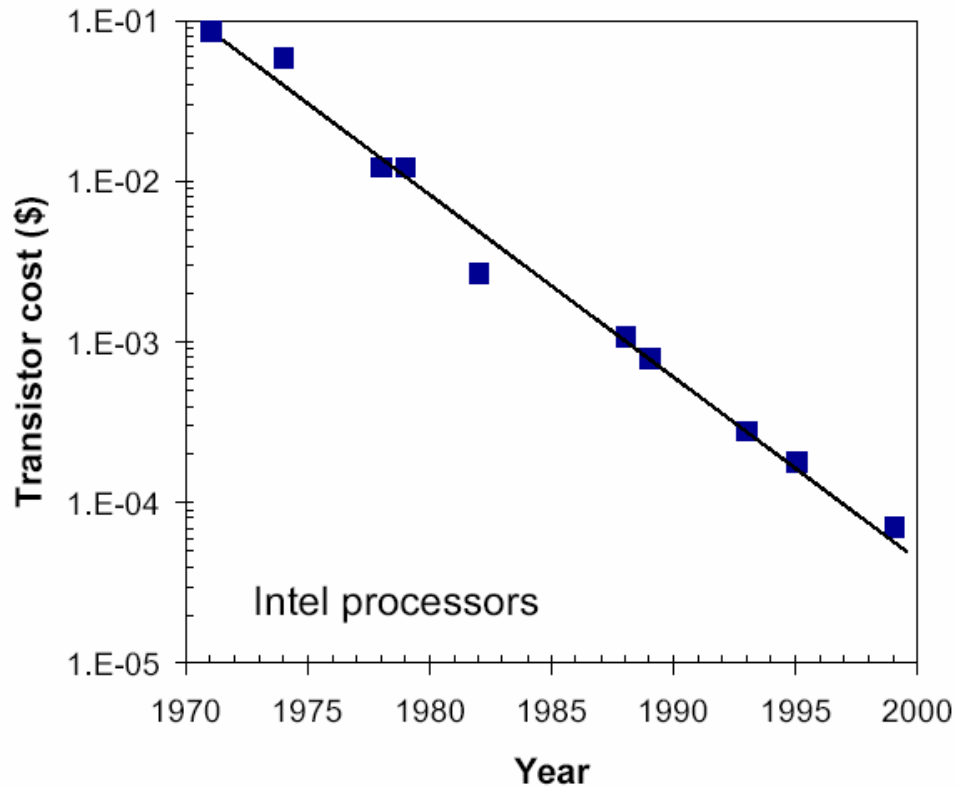
Experimental SOI microprocessor from IBM

# Clock speed



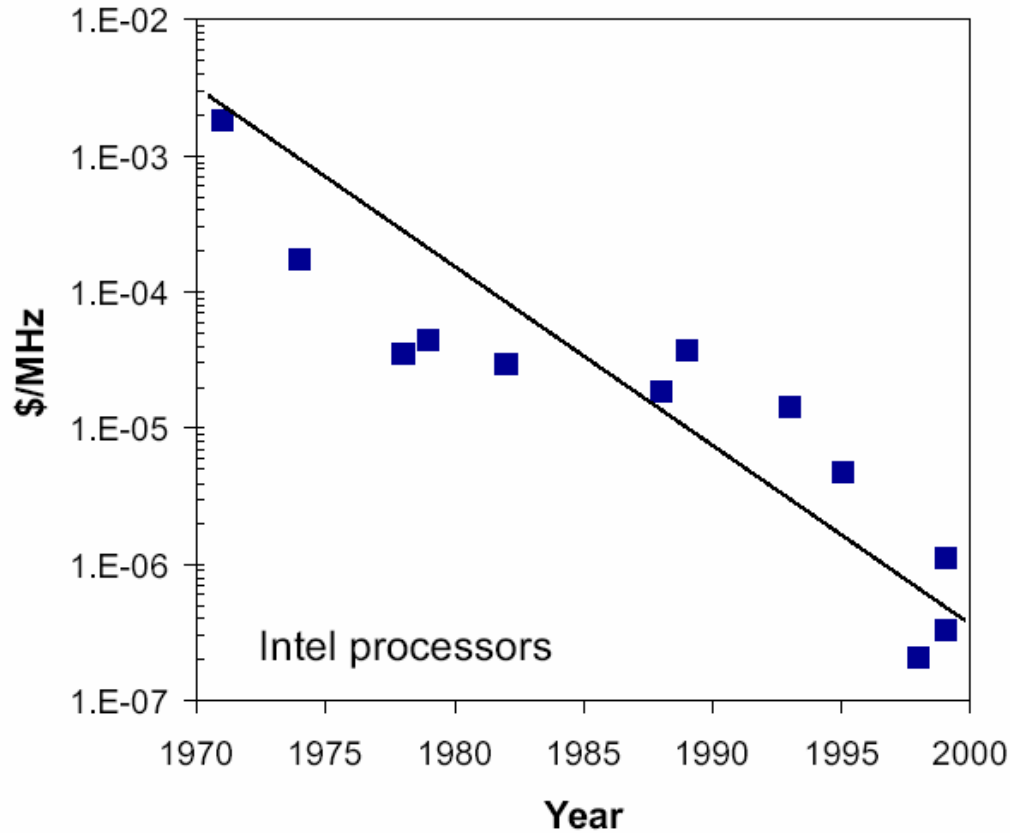
4-orders of magnitude improvement in 30 years.

# Transistor cost



3-order of  
magnitude reduction  
in 30 years.

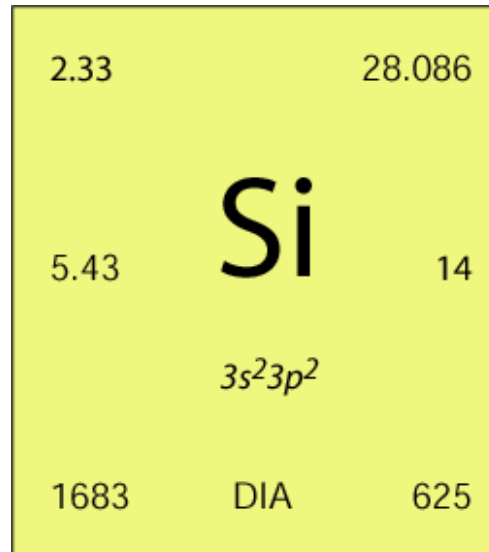
# Cost per function



4-order of magnitude reduction in 30 years.

# Keys to success of digital microelectronics:

## I. Silicon

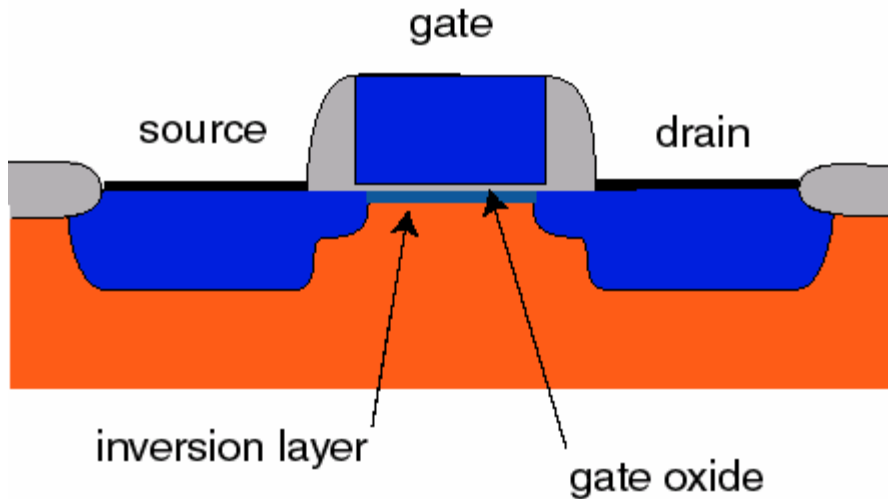


- Cheap and abundant
- Amazing mechanical, chemical and electronic properties
- Probably, the material best known to humankind

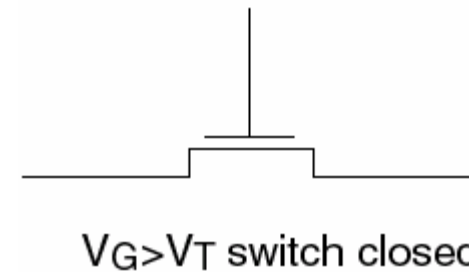
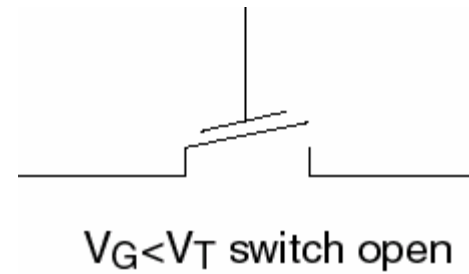
# Keys to success of digital microelectronics:

## II. MOSFET

Metal-Oxide-Semiconductor  
Field-Effect Transistor



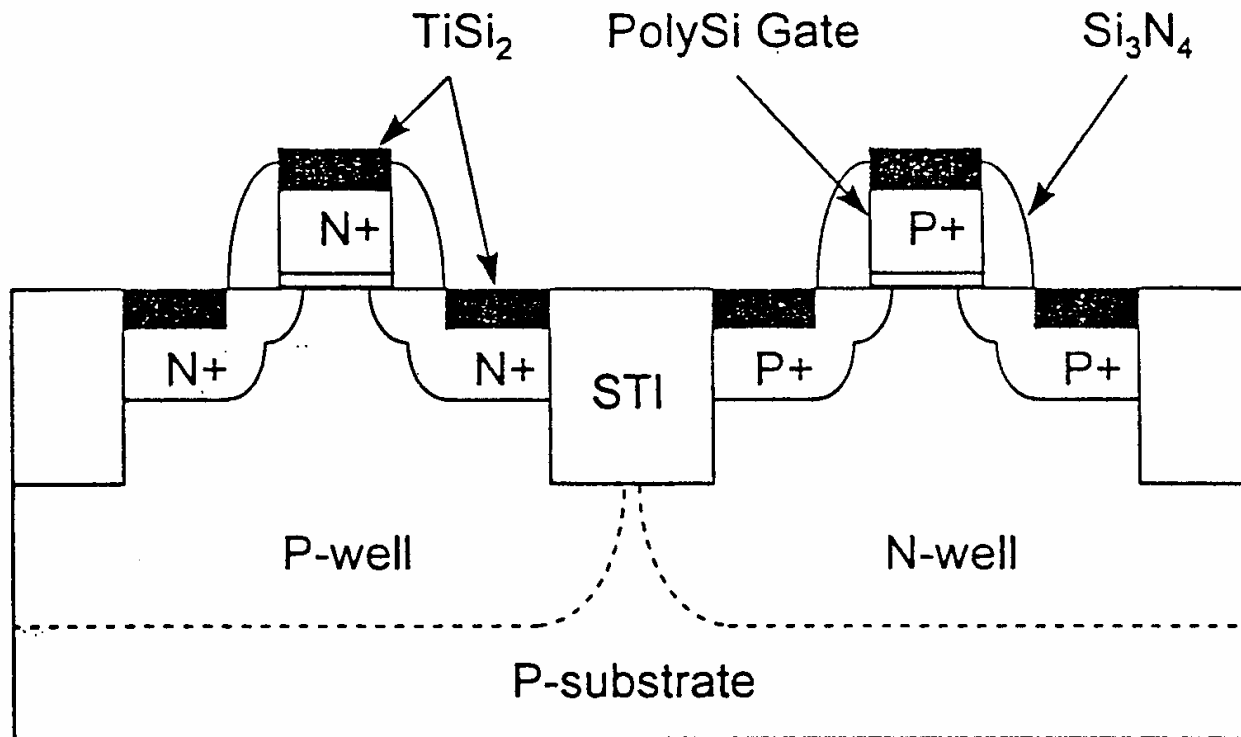
MOSFET = switch



Good gain, isolation, and speed

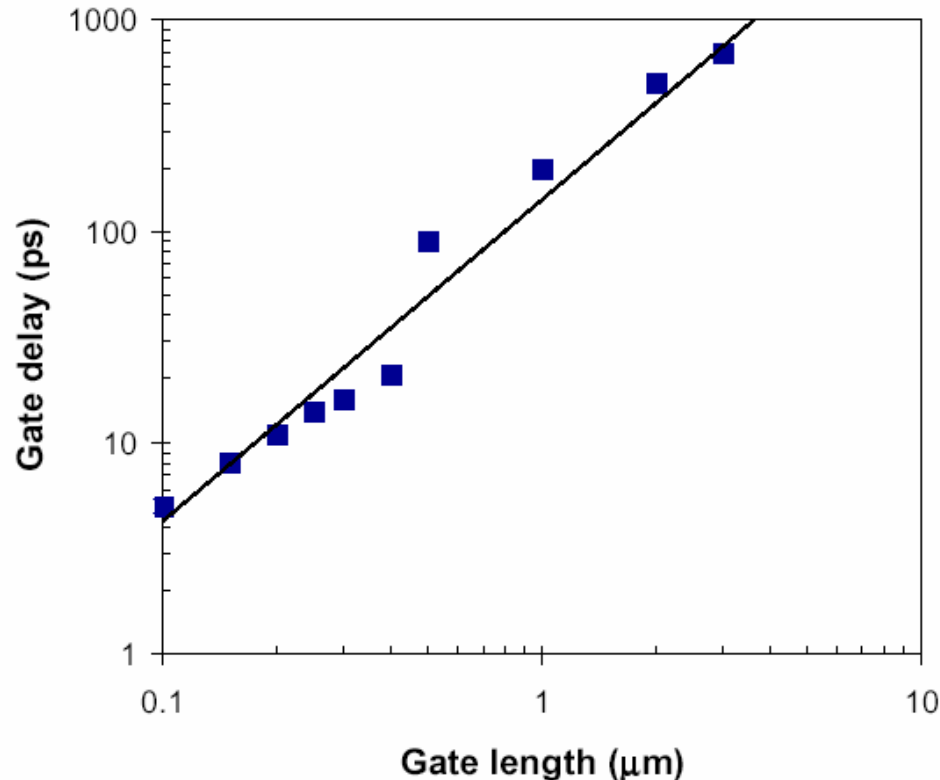


# Modern MOSFET structure



# Keys to success of digital microelectronics:

## III. MOSFET scaling



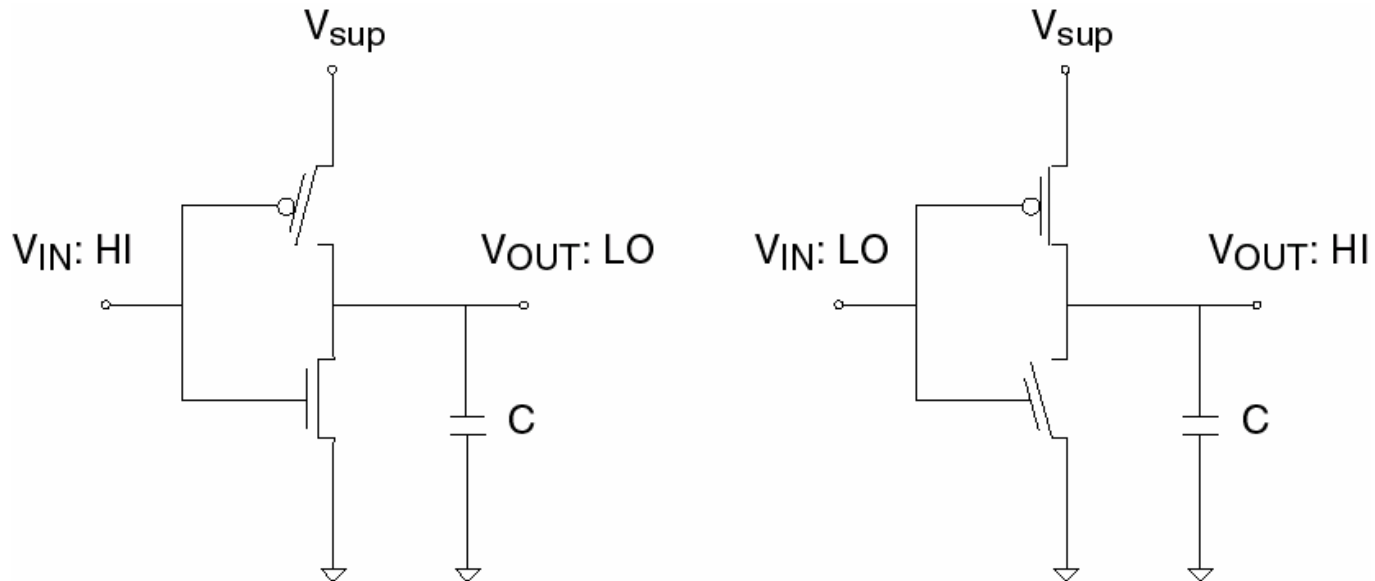
MOSFET performance improves as size is decreased:

- Shorter switching time
- Lower power consumption

# Keys to success of digital microelectronics:

## IV. CMOS

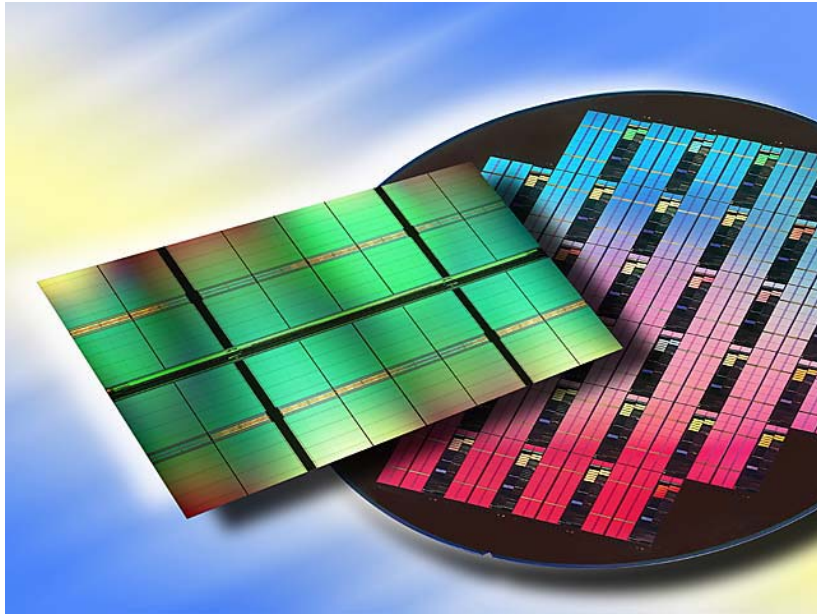
CMOS: Complementary Metal-Oxide-Semiconductor



- “Complementary” switch activates with  $V < 0$ .
- Logic without DC power consumption.

# Keys to success of digital microelectronics:

## V. Microfabrication technology



- Tight integration of dissimilar devices with good isolation
- Fabrication of extremely small structures, precisely and reproducibly
- High-volume manufacturing of complex systems with high yield.

1 Gbit DRAM from IBM

# Keys to success of digital microelectronics:

## VI. Circuit engineering

- Simple device models that:
  - are based on physics
  - allow analog and digital circuit design
  - permit assessment of impact of device variations on circuit performance
- Circuit design techniques that:
  - are tolerant to logic level fluctuations, noise and crosstalk
  - are insensitive to manufacturing variations
  - require little power consumption

# Content of 6.012

- Deals with **microelectronic devices**
  - Semiconductor physics
  - Metal-oxide-semiconductor field-effect transistor (MOSFET)
  - Bipolar junction transistor (BJT)
- Deals with **microelectronic circuits**
  - Digital circuits (mainly CMOS)
  - Analog circuits (BJT and MOS)
- The interaction of devices and circuits